

**SOT-26**

**Pin Definition:**

- 1. Drain 6. Drain
- 2. Drain 5. Drain
- 3. Gate 4. Source

**PRODUCT SUMMARY**

<b>V<sub>DS</sub> (V)</b>	<b>R<sub>DS(on)</sub>(mΩ)</b>	<b>I<sub>D</sub> (A)</b>
<b>-30</b>	<b>100 @ V<sub>GS</sub> = -10V</b>	<b>-3.5</b>
	<b>170 @ V<sub>GS</sub> = -4.5V</b>	<b>-2.7</b>

**Features**

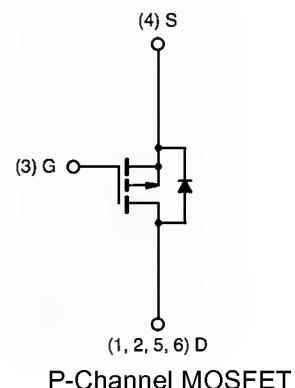
- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

**Application**

- Load Switch
- PA Switch

**Ordering Information**

<b>Part No.</b>	<b>Package</b>	<b>Packing</b>
TSM3455CX6 RF	SOT-26	3Kpcs / 7" Reel

**Block Diagram**

**Absolute Maximum Rating** (Ta = 25°C unless otherwise noted)

<b>Parameter</b>	<b>Symbol</b>	<b>Limit</b>	<b>Unit</b>
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	-3.5	A
Pulsed Drain Current	I <sub>DM</sub>	-20	A
Continuous Source Current (Diode Conduction) <sup>a,b</sup>	I <sub>S</sub>	-1.7	A
Maximum Power Dissipation	P <sub>D</sub>	2.0	W
		1.3	
Operating Junction Temperature	T <sub>J</sub>	+150	°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to +150	°C

**Thermal Performance**

<b>Parameter</b>	<b>Symbol</b>	<b>Limit</b>	<b>Unit</b>
Junction to Case Thermal Resistance	R<θ <sub>JF</sub>	62.5	°C/W
Junction to Ambient Thermal Resistance (PCB mounted)	R<θ <sub>JA</sub>	110	°C/W

Notes:

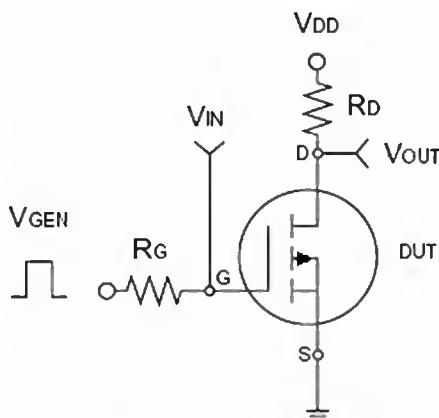
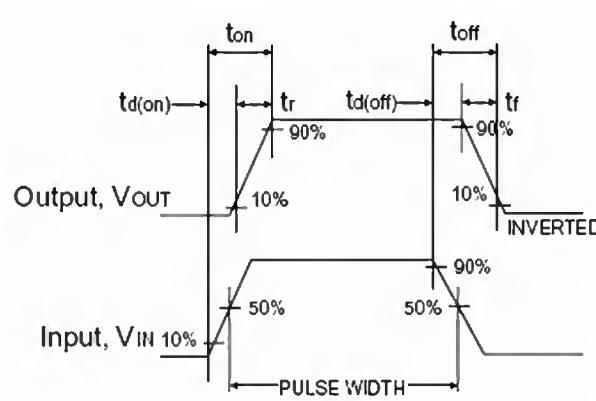
- a. Pulse width limited by the Maximum junction temperature
- b. Surface Mounted on FR4 Board, t ≤ 5 sec.

**Electrical Specifications (Ta = 25°C unless otherwise noted)**

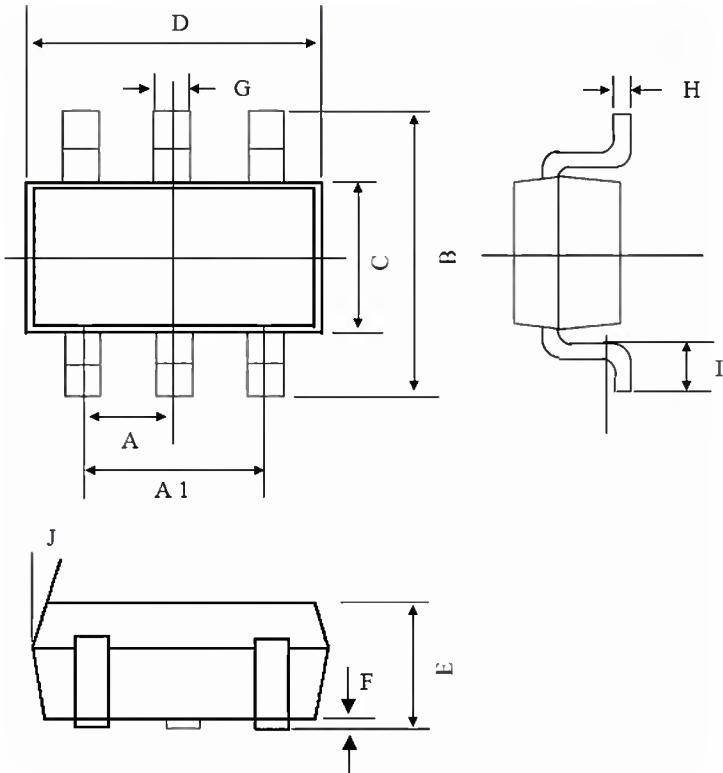
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	$BV_{DSS}$	-30	--	--	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu A$	$V_{GS(TH)}$	-1	--	-3	V
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	$I_{GSS}$	--	--	$\pm 100$	nA
Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V$	$I_{DSS}$	--	--	-1.0	$\mu A$
On-State Drain Current <sup>a</sup>	$V_{DS} \leq -5V, V_{GS} = -10V$	$I_{D(ON)}$	-6	--	--	A
Drain-Source On-State Resistance <sup>a</sup>	$V_{GS} = -10V, I_D = -3.5A$	$R_{DS(ON)}$	--	80	100	$m\Omega$
	$V_{GS} = -4.5V, I_D = -2.7A$		--	140	170	
Forward Transconductance <sup>a</sup>	$V_{DS} = -15V, I_D = -3.5A$	$g_{fs}$	--	6	--	S
Diode Forward Voltage	$I_S = -1.7A, V_{GS} = 0V$	$V_{SD}$	--	--	-1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$V_{DS} = -15V, I_D = -3.5A, V_{GS} = -10V$	$Q_g$	--	10	15	nC
Gate-Source Charge		$Q_{gs}$	--	1.9	--	
Gate-Drain Charge		$Q_{gd}$	--	2	--	
Input Capacitance	$V_{DS} = -15V, V_{GS} = 0V, f = 1.0MHz$	$C_{iss}$	--	565	--	pF
Output Capacitance		$C_{oss}$	--	126	--	
Reverse Transfer Capacitance		$C_{rss}$	--	75	--	
<b>Switching<sup>c</sup></b>						
Turn-On Delay Time	$V_{DD} = -15V, R_L = 15\Omega, I_D = -1A, V_{GEN} = -10V, R_G = 6\Omega$	$t_{d(on)}$	--	10	20	nS
Turn-On Rise Time		$t_r$	--	9	20	
Turn-Off Delay Time		$t_{d(off)}$	--	27	50	
Turn-Off Fall Time		$t_f$	--	7	16	

**Notes:**

- pulse test: PW  $\leq 300\mu S$ , duty cycle  $\leq 2\%$
- For DESIGN AID ONLY, not subject to production testing.
- Switching time is essentially independent of operating temperature.

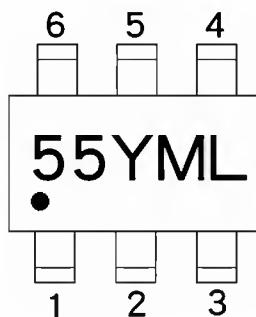

**Switching Test Circuit**

**Switching Waveforms**

## SOT-26 Mechanical Drawing



DIM	SOT-26 DIMENSION			INCHES		
	MILLIMETERS			INCHES		
	MIN	_TYP	MAX	MIN	_TYP	MAX
A	0.95	BSC		0.0374	BSC	
A1	1.9	BSC		0.0748	BSC	
B	2.60	2.80	3.00	0.1024	0.1102	0.1181
C	1.40	1.50	1.70	0.0551	0.0591	0.0669
D	2.80	2.90	3.10	0.1101	0.1142	0.1220
E	1.00	1.10	1.20	0.0394	0.0433	0.0472
F	0.00	--	0.10	0.00	--	0.0039
G	0.35	0.40	0.50	0.0138	0.0157	0.0197
H	0.10	0.15	0.20	0.0039	0.0059	0.0079
I	0.30	--	0.60	0.0118	--	0.0236
J	5°	--	10°	5°	--	10°

## Marking Diagram



**55** = Device Code  
**Y** = Year Code  
**M** = Month Code  
 (A=Jan, B=Feb, C=Mar, D=Apl, E=May, F=Jun, G=Jul, H=Aug,  
 I=Sep, J=Oct, K=Nov, L=Dec)  
**L** = Lot Code

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